

# HAT3021R

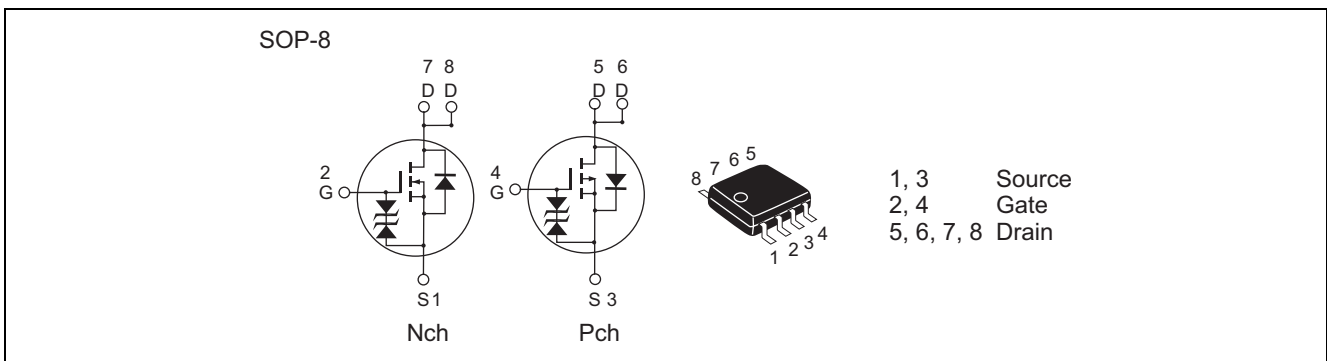
Silicon N/P Channel Power MOS FET  
Power Switching

REJ03G0415-020F  
Rev.2.0F  
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## Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting

## Outline



## Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings		Unit
		Nch	Pch	
Drain to source voltage	$V_{DSS}$	80	-80	V
Gate to source voltage	$V_{GSS}$	±20	±20	V
Drain current	$I_D$	3.4	-2.6	A
Drain peak current	$I_{D(pulse)}$ <sup>Note1</sup>	20.4	-15.6	A
Body-drain diode reverse drain current	$I_{DR}$	3.4	-2.6	A
Channel dissipation	$P_{ch}$ <sup>Note2</sup>	1.5	1.5	W
Channel temperature	$T_{ch}$	150		°C
Storage temperature	$T_{stg}$	-55 to +150		°C

Notes: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$

2. 1 Drive operation; When using the glass epoxy board (FR4 40 x 40 x 1.6 mm),  $PW \leq 10s$

## Electrical Characteristics

(Ta = 25°C)

## • N Channel

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	80	—	—	V	$I_D = 10 \text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	$\pm 20$	—	—	V	$I_G = \pm 100 \text{ }\mu\text{A}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 10$	$\mu\text{A}$	$V_{GS} = \pm 16 \text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	1	$\mu\text{A}$	$V_{DS} = 80 \text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.5	V	$V_{DS} = 10 \text{ V}$ , $I_D = 1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	90	115	$\text{m}\Omega$	$I_D = 1.7 \text{ A}$ , $V_{GS} = 10 \text{ V}$ <sup>Note4</sup>
	$R_{DS(on)}$	—	100	145	$\text{m}\Omega$	$I_D = 1.7 \text{ A}$ , $V_{GS} = 4.5 \text{ V}$ <sup>Note4</sup>
Forward transfer admittance	$ y_{fs} $	4.2	7.0	—	S	$I_D = 1.7 \text{ A}$ , $V_{DS} = 10 \text{ V}$ <sup>Note4</sup>
Input capacitance	$C_{iss}$	—	400	—	pF	$V_{DS} = 10 \text{ V}$
Output capacitance	$C_{oss}$	—	57	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	$C_{rss}$	—	24	—	pF	$f = 1 \text{ MHz}$
Total gate charge	$Q_g$	—	7.3	—	nC	$V_{DD} = 25 \text{ V}$
Gate to source charge	$Q_{gs}$	—	1.1	—	nC	$V_{GS} = 10 \text{ V}$
Gate to drain charge	$Q_{gd}$	—	1.3	—	nC	$I_D = 3.4 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	6.0	—	ns	$V_{GS} = 10 \text{ V}$ , $I_D = 1.7 \text{ A}$
Rise time	$t_r$	—	4.0	—	ns	$V_{DD} \cong 30 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	39	—	ns	$R_L = 17.6 \text{ }\Omega$
Fall time	$t_f$	—	3.5	—	ns	$R_g = 4.7 \text{ }\Omega$
Body-drain diode forward voltage	$V_{DF}$	—	0.83	1.08	V	$I_F = 3.4 \text{ A}$ , $V_{GS} = 0$ <sup>Note4</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	30	—	ns	$I_F = 3.4 \text{ A}$ , $V_{GS} = 0$ $diF/dt = 100 \text{ A}/\mu\text{s}$

Notes: 4. Pulse test

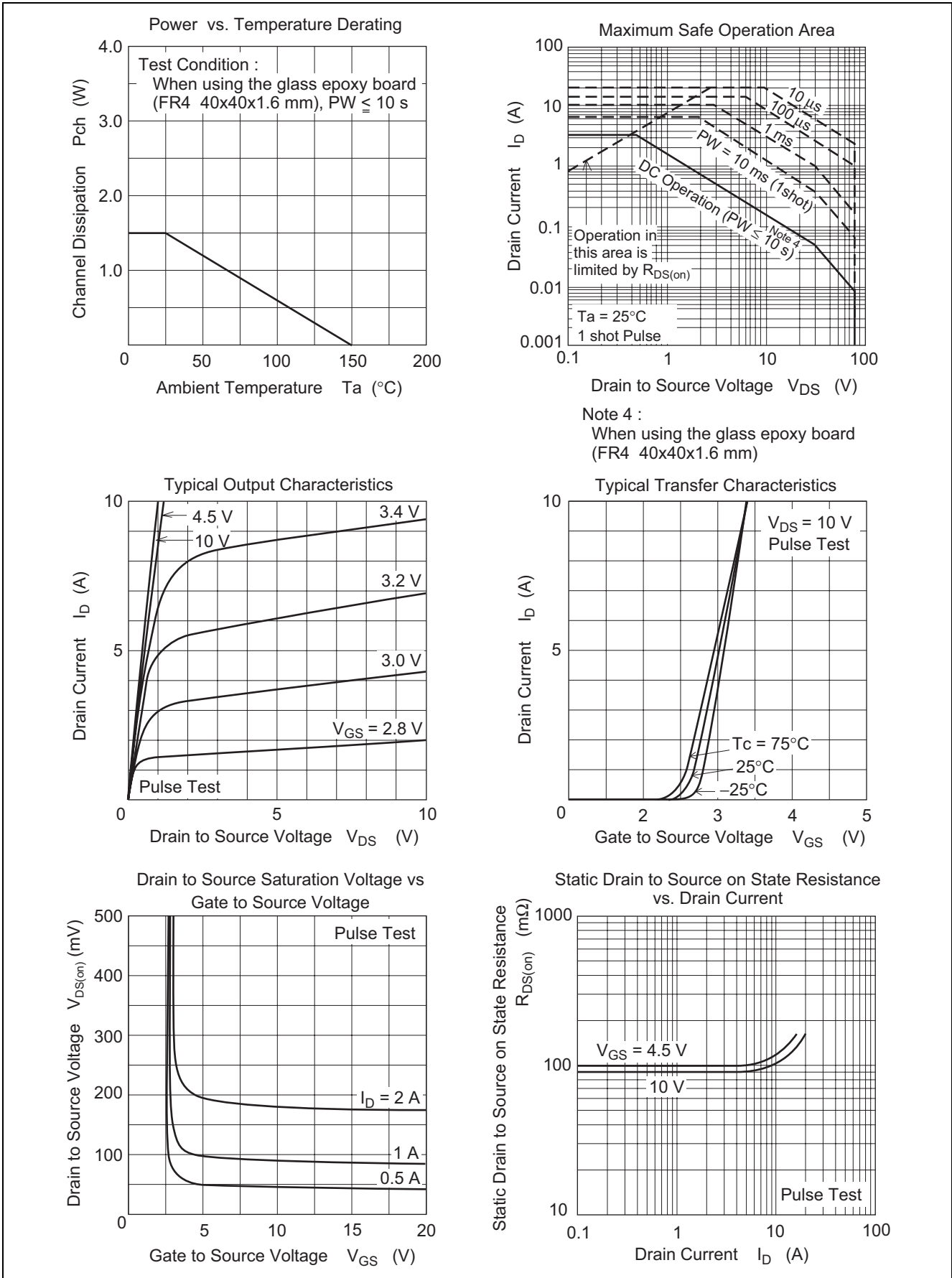
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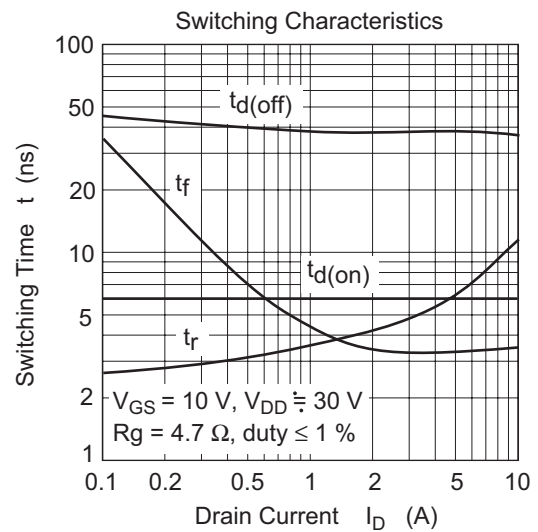
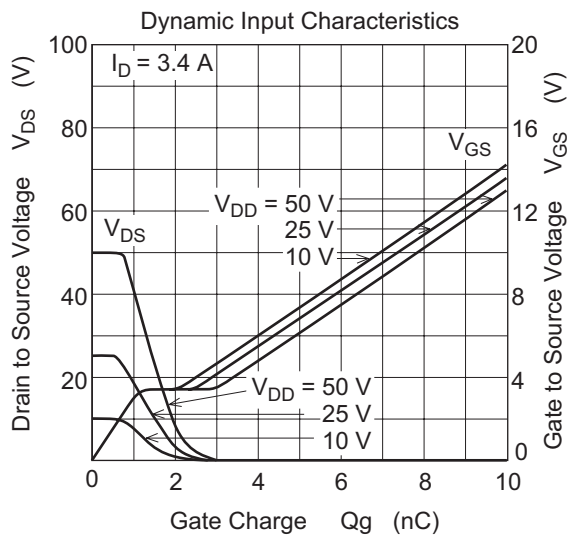
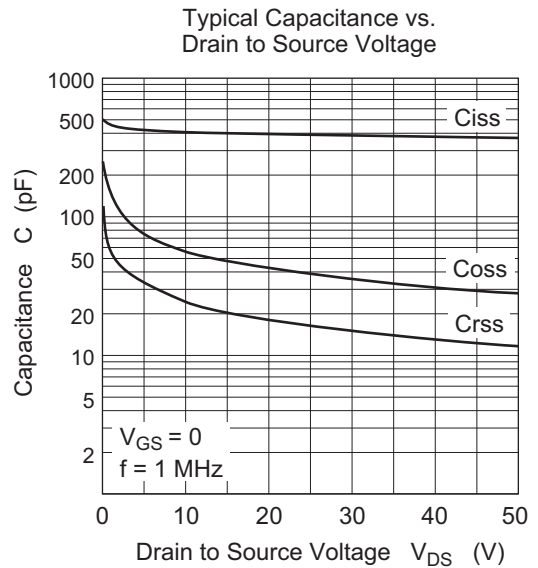
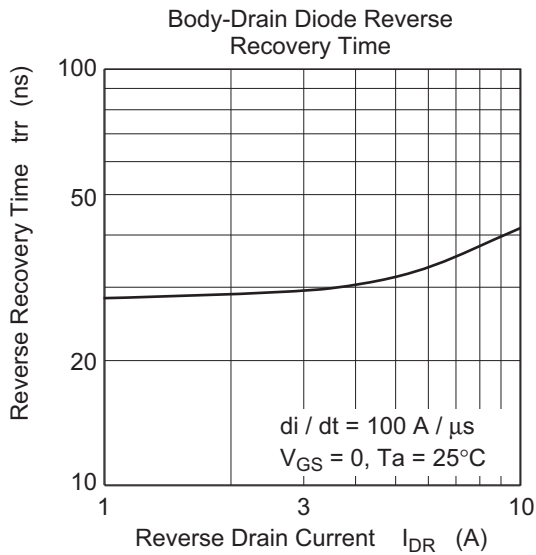
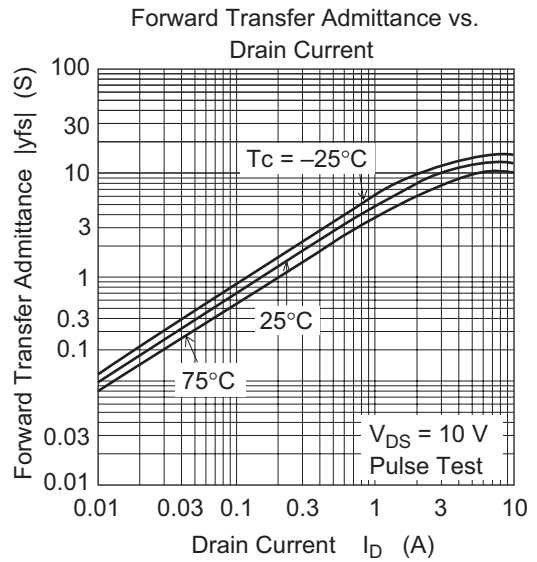
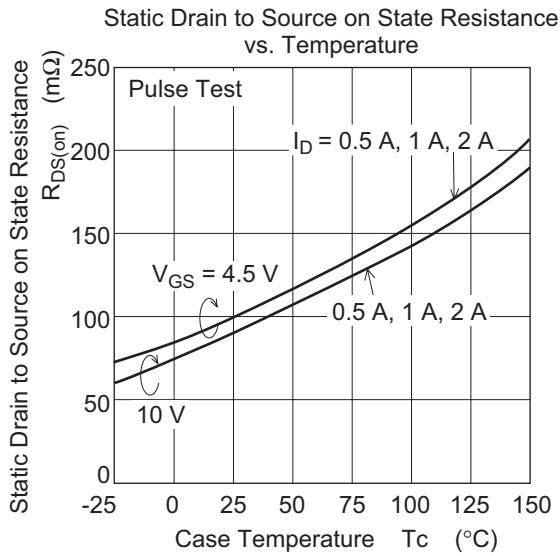
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-80	—	—	V	$I_D = -10 \text{ mA}$ , $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	$\pm 20$	—	—	V	$I_G = \pm 100 \mu\text{A}$ , $V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	$\pm 10$	$\mu\text{A}$	$V_{GS} = \pm 16 \text{ V}$ , $V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	-1	$\mu\text{A}$	$V_{DS} = -80 \text{ V}$ , $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.5	V	$V_{DS} = -10 \text{ V}$ , $I_D = -1 \text{ mA}$
Static drain to source on state resistance	$R_{DS(on)}$	—	165	210	$\text{m}\Omega$	$I_D = -1.3 \text{ A}$ , $V_{GS} = -10 \text{ V}$ <sup>Note4</sup>
	$R_{DS(on)}$	—	200	290	$\text{m}\Omega$	$I_D = -1.3 \text{ A}$ , $V_{GS} = -4.5 \text{ V}$ <sup>Note4</sup>
Forward transfer admittance	$ y_{fs} $	2.0	3.3	—	S	$I_D = -1.3 \text{ A}$ , $V_{DS} = -10 \text{ V}$ <sup>Note4</sup>
Input capacitance	$C_{iss}$	—	930	—	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	$C_{oss}$	—	90	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	$C_{rss}$	—	56	—	pF	$f = 1 \text{ MHz}$
Total gate charge	$Q_g$	—	16	—	nC	$V_{DD} = -25 \text{ V}$
Gate to source charge	$Q_{gs}$	—	2.1	—	nC	$V_{GS} = -10 \text{ V}$
Gate to drain charge	$Q_{gd}$	—	2.4	—	nC	$I_D = -2.6 \text{ A}$
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$V_{GS} = -10 \text{ V}$ , $I_D = -1.3 \text{ A}$
Rise time	$t_r$	—	12	—	ns	$V_{DD} \approx -30 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	40	—	ns	$R_L = 23.0 \Omega$
Fall time	$t_f$	—	5.5	—	ns	$R_g = 4.7 \Omega$
Body-drain diode forward voltage	$V_{DF}$	—	-0.83	-1.08	V	$I_F = -2.6 \text{ A}$ , $V_{GS} = 0$ <sup>Note4</sup>
Body-drain diode reverse recovery time	$t_{rr}$	—	30	—	ns	$I_F = -2.6 \text{ A}$ , $V_{GS} = 0$ $diF/dt = 100 \text{ A}/\mu\text{s}$

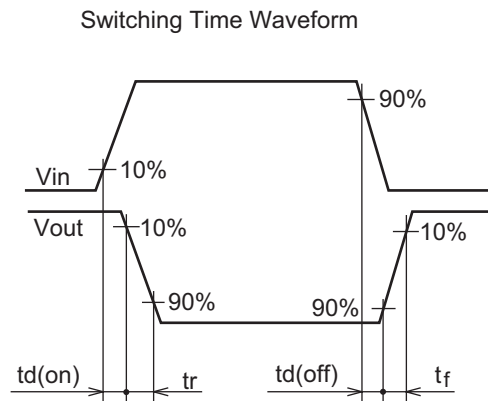
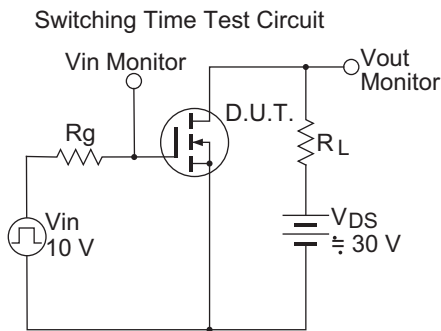
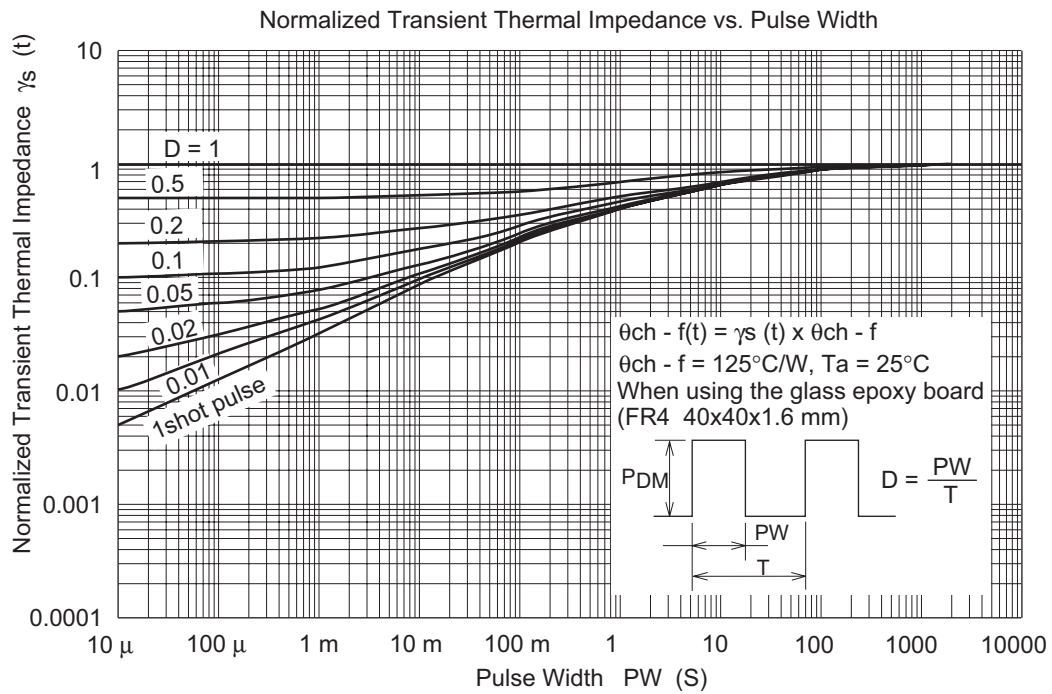
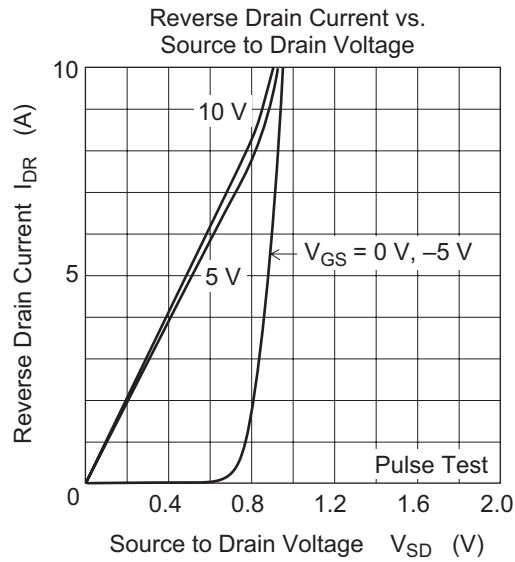
Notes: 4. Pulse test

## Main Characteristics

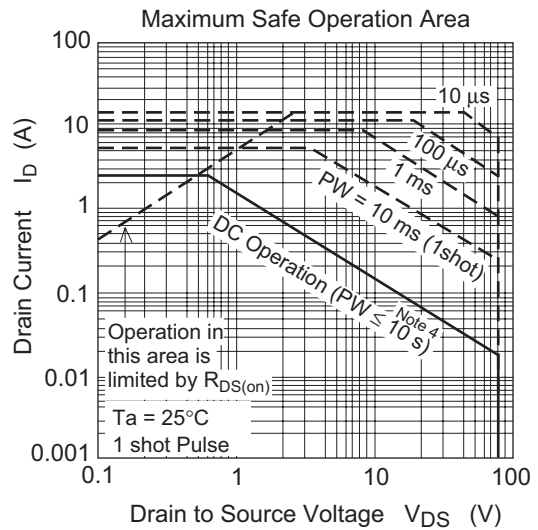
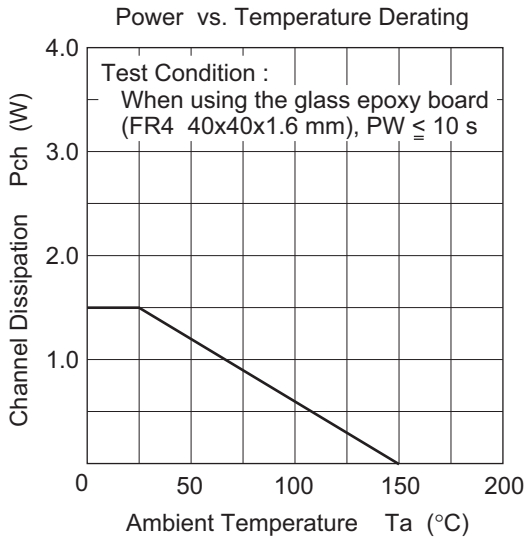
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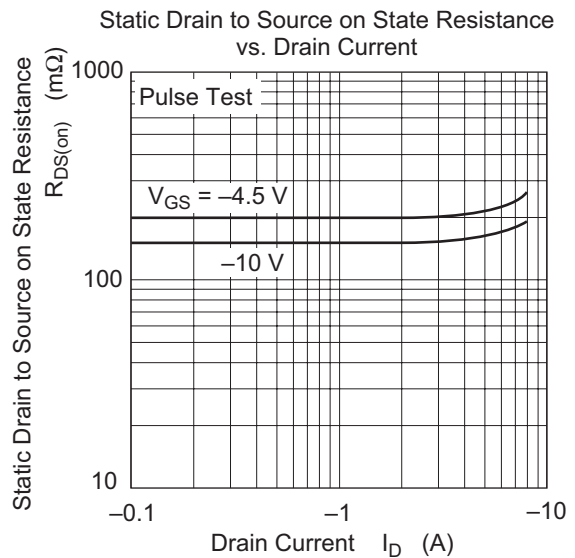
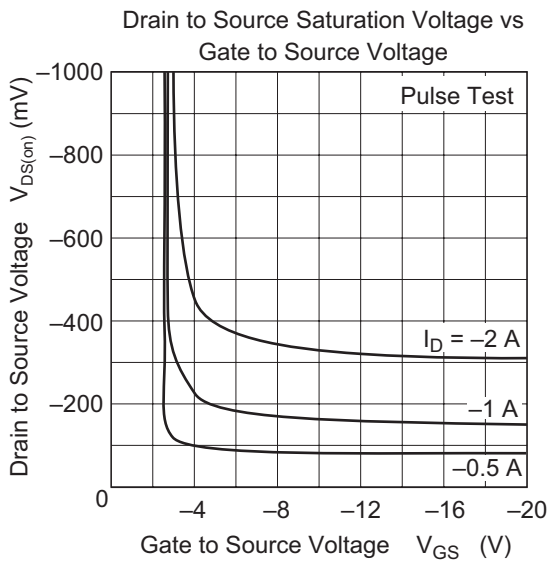
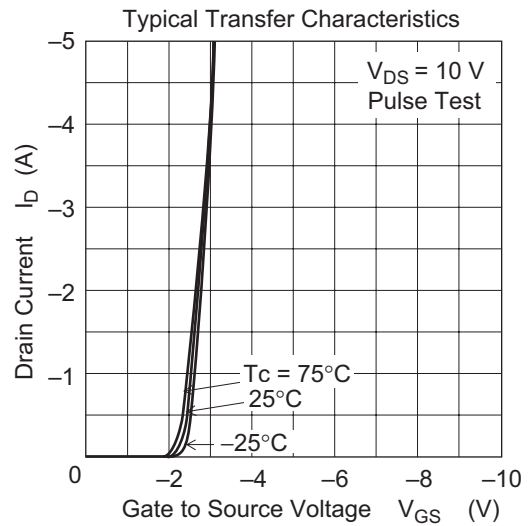
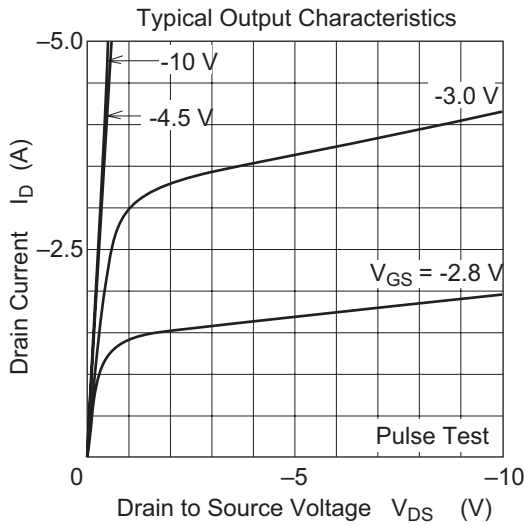


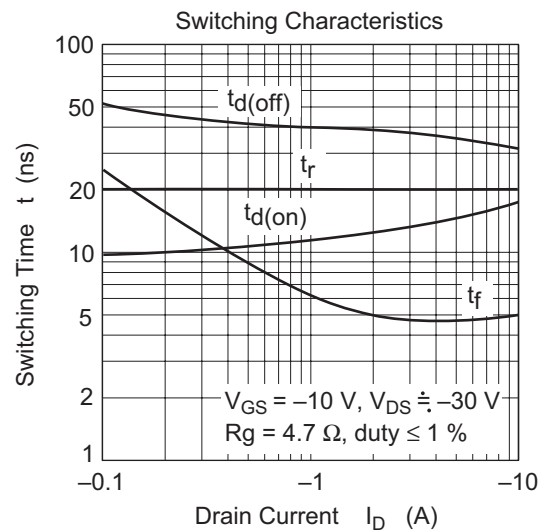
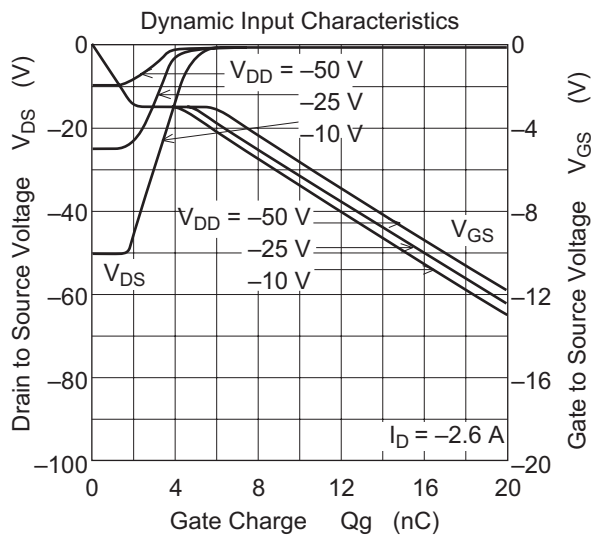
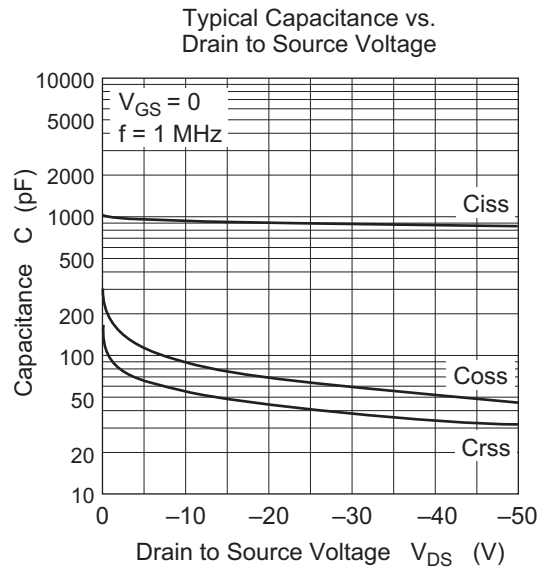
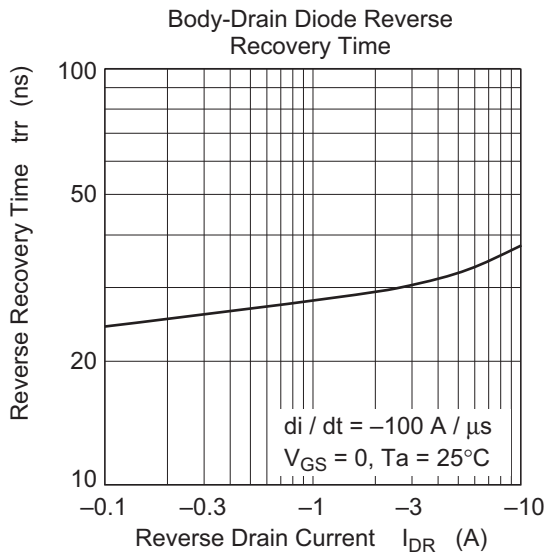
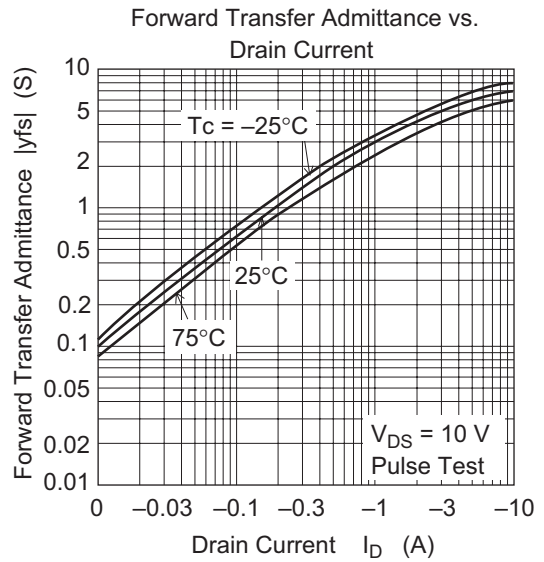
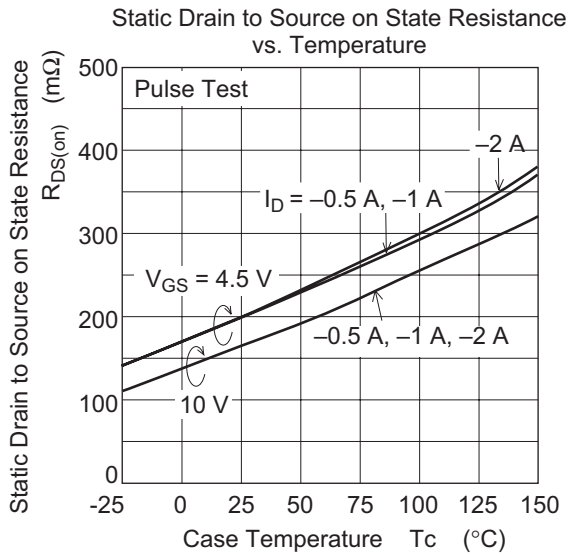


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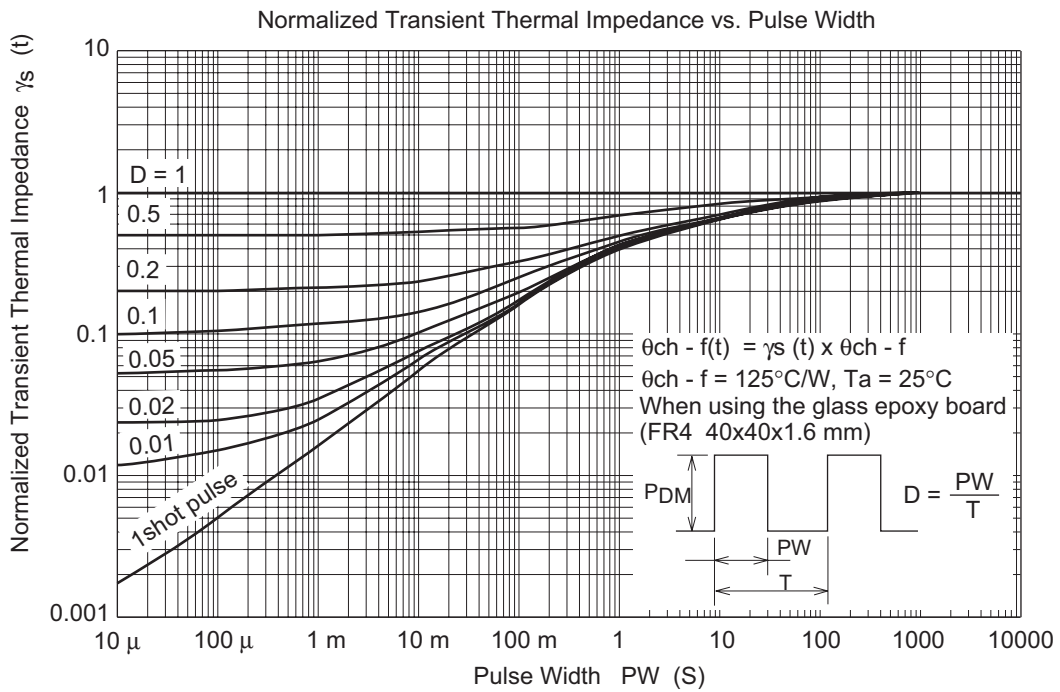
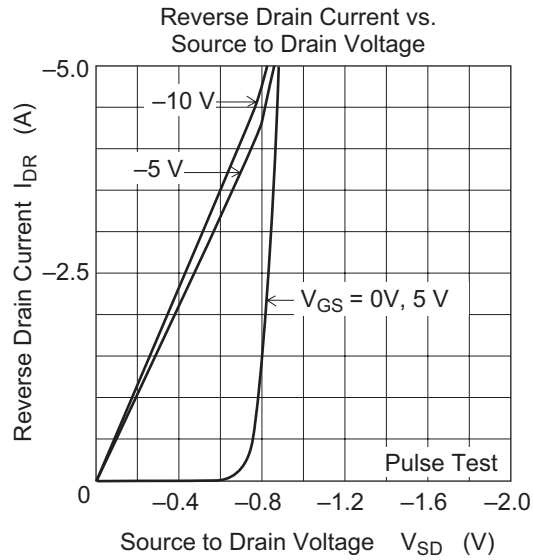


Note 4 :  
When using the glass epoxy board (FR4 40x40x1.6 mm)

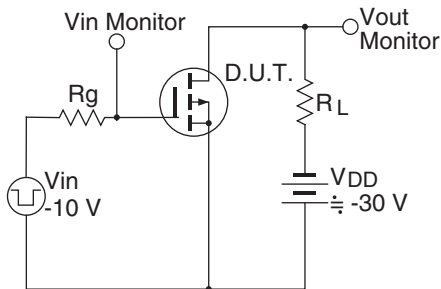




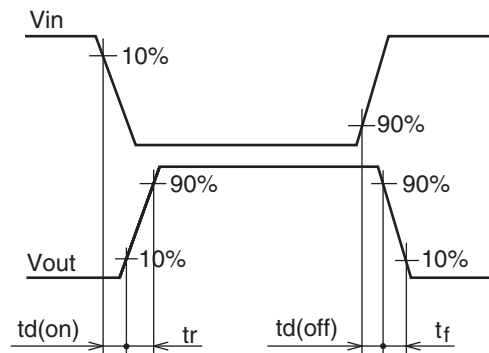




Switching Time Test Circuit

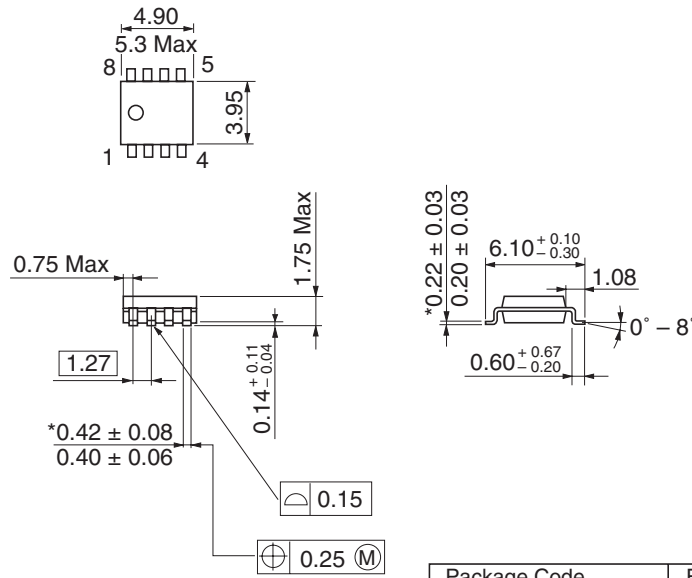


Switching Time Waveform



Package Dimensions

As of January, 2003  
Unit: mm



\*Dimension including the plating thickness  
Base material dimension

Package Code	FP-8DA
JEDEC	Conforms
JEITA	—
Mass (reference value)	0.085 g

Ordering Information

Part Name	Quantity	Shipping Container
HAT3021R-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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6. 使用本文件中记载的瑞萨电子产品时，应在瑞萨电子指定的范围内，特别是在最大额定值、电源工作电压范围、移动电源电压范围、热辐射特性、安装条件以及其他产品特性的范围内使用。对于在上述指定范围之外使用瑞萨电子产品而产生的故障或损失，瑞萨电子不承担任何责任。
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8. 关于环境保护方面的详细内容，例如每种瑞萨电子产品的环境兼容性等，请与瑞萨电子的营业部门联系。使用瑞萨电子产品时，请遵守对管制物质的使用或含量进行管理的所有相应法律法规（包括但不限于《欧盟RoHS指令》）。对于因用户未遵守相应法律法规而导致的损害或损失，瑞萨电子不承担任何责任。
9. 不可将瑞萨电子产品和技术用于或者嵌入日本国内或海外相应的法律法规所禁止生产、使用及销售的任何产品或系统中。也不可将本文件中记载的瑞萨电子产品或技术用于与军事应用或者军事用途有关的目的（如大规模杀伤性武器的开发等）。在将本文件中记载的瑞萨电子产品或技术进行出口时，应当遵守相应的出口管制法律法规，并按照上述法律法规所规定的程序进行。
10. 向第三方分销或处分产品或者以其他方式将产品置于第三方控制之下的瑞萨电子产品买方或分销商，有责任事先向上述第三方通知本文件规定的内容和条件；对于用户或第三方因非法使用瑞萨电子产品而遭受的任何损失，瑞萨电子不承担任何责任。
11. 在事先未得到瑞萨电子书面认可的情况下，不得以任何形式部分或全部转载或复制本文件。
12. 如果对本文件所记载的信息或瑞萨电子产品有任何疑问，或者用户有任何其他疑问，请向瑞萨电子的营业部门咨询。  
(注1) 瑞萨电子：在本文件中指瑞萨电子株式会社及其控股子公司。  
(注2) 瑞萨电子产品：指瑞萨电子开发或生产的任何产品。



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